

FDB0630N1507L N-Channel PowerTrench[®] MOSFET 150 V, 130 A, $6.4 \text{ m}\Omega$

Features

- Max r_{DS(on)} = 6.4 mΩ at V_{GS} = 10 V, I_D = 18 A
- Fast Switching Speed
- Low Gate Charge
- \blacksquare High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- High Power and Current Handling Capability
- RoHS Compliant

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications.

Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25°C	(Note 5)	130		
	-Continuous	T _C = 100°C	(Note 5)	90	Α	
	-Pulsed		(Note 4)	720		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	693	mJ	
P _D	Power Dissipation	T _C = 25°C		300	W	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.8	V	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

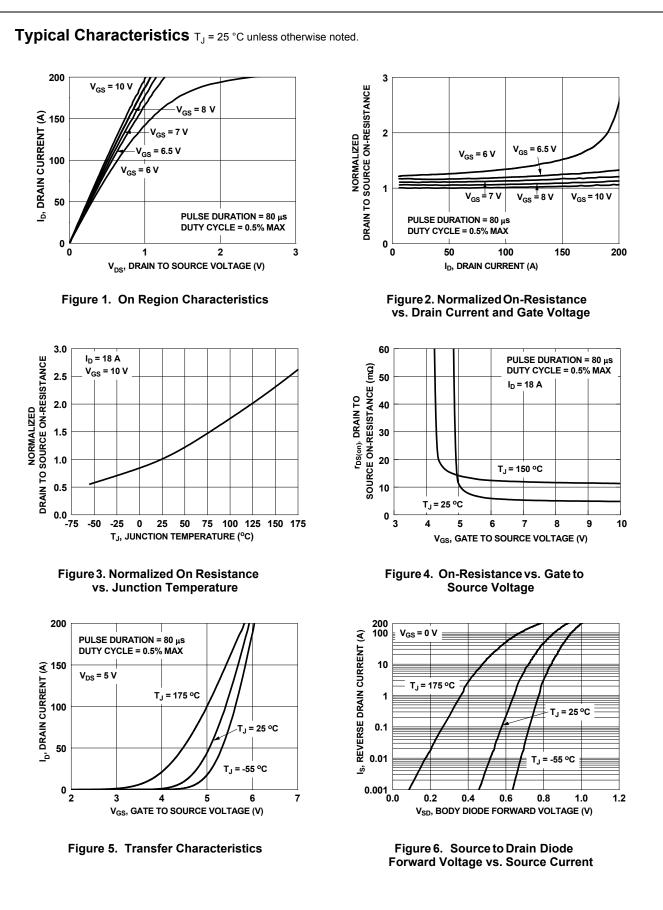
Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	0.5	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	0/10

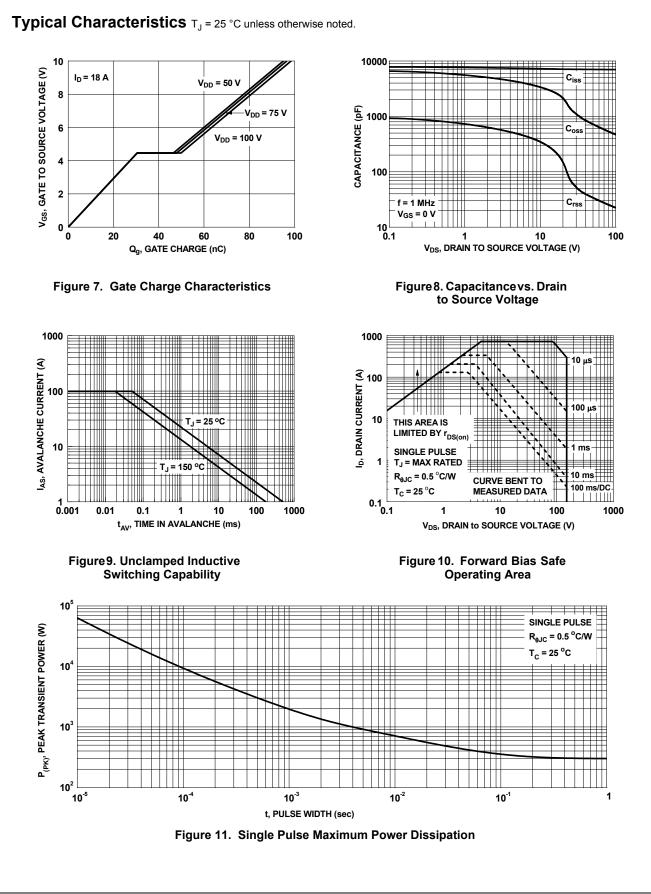
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB0630N1507L	FDB0630N1507L	D2-PAK-7L	330mm	24mm	800 units

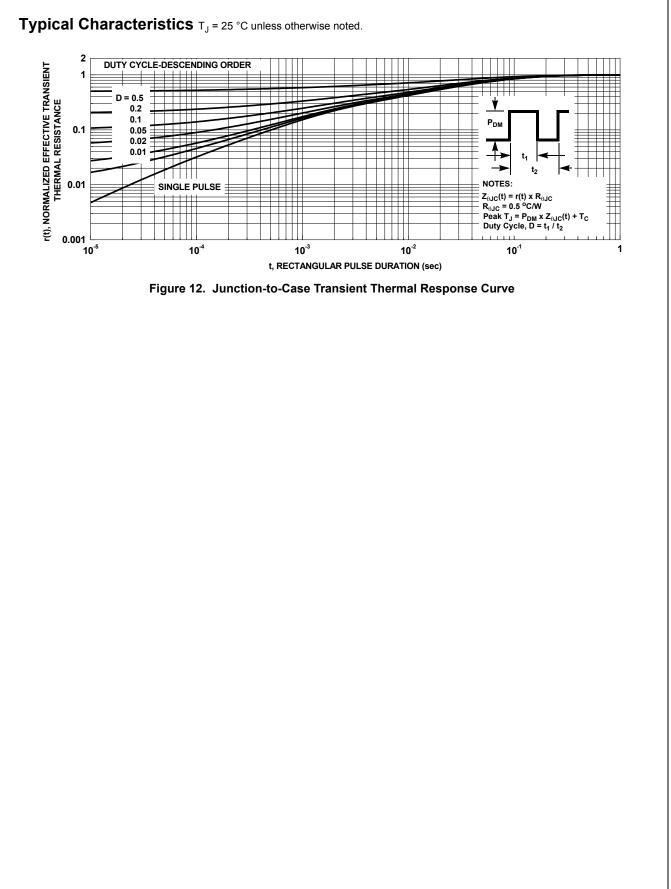
		Test Conditions	Min.	Тур.	Max.	Units
Jff Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
ABV _{DSS}	Breakdown Voltage Temperature					
ΔT_J	Coefficient	I_D = 250 $\mu A,$ referenced to 25 $^\circ C$		92		mV/°C
DSS	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
GSS	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Charac	steristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	2.9	4	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage					
ΔT_J	Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		-13		mV/°C
	Statia Drain to Source On Desistance	V _{GS} = 10 V, I _D = 18 A		4.9	6.4	mΩ
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 18 A, T _J = 150°C		11	26	
Ĵfs	Forward Transconductance	V _{DS} = 10 V, I _D = 18 A		63		S
)vnamic (Characteristics					
	Input Capacitance			7065	9895	pF
	Output Capacitance	– V _{DS} = 75 V, V _{GS} = 0 V,		552	775	pF
C _{oss}	Reverse Transfer Capacitance	f = 1 MHz		27	50	pF
C _{rss} ⋜ _g	Gate Resistance			2.5	50	Ω
Switching	Characteristics					
d(on)	Turn-On Delay Time			33	52	ns
•r	Rise Time	V _{DD} = 75 V, I _D = 18 A,		31	53	ns
d(off)	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		60	96	ns
f	Fall Time			17	30	ns
С ^д	Total Gate Charge	– V _{DD} = 75 V, I _D = 18 A,		97	135	nC
ସୁ _{gs}	Gate to Source Gate Charge	$V_{DD} = 75 \text{ V}, \text{ I}_{D} = 18 \text{ A},$ $-V_{GS} = 10 \text{ V}$		30		nC
ପୁ _{gd}	Gate to Drain "Miller" Charge	.63 .01		17		nC
Drain-Sou	rce Diode Characteristics					
S	Maximum Continuous Drain to Source Diod	tinuous Drain to Source Diode Forward Current			130	А
SM	Maximum Pulsed Drain to Source Diode Fo				720	Α
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 18 A$ (Note 2)		0.8	1.2	V
·rr	Reverse Recovery Time			107	172	ns
Qrr	Reverse Recovery Charge	— I _F = 18 A, di/dt = 100 A/μs		229	366	nC
R _{θJC} is guarante a) 40 °C/V	to of the junction-to-case and case-to-ambient thermal resist eed by design while $R_{\theta CA}$ is determined by the user's boar N when mounted on a 1 in ² pad of 2 oz copper. NW when mounted on a minimum pad of 2 oz copper.		as the solde	er mounting s	urface of the	e drain pins.

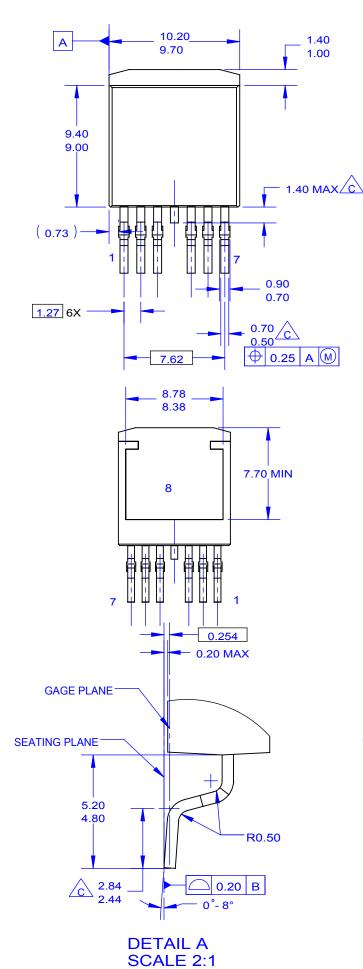


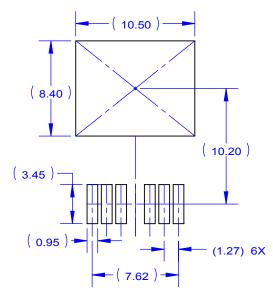
FDB0630N1507L N-Channel PowerTrench[®] MOSFET



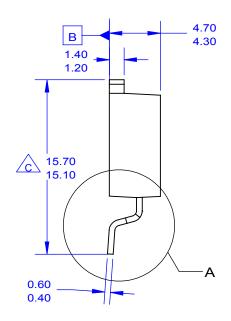
FDB0630N1507L N-Channel PowerTrench[®] MOSFET







LAND PATTERN RECOMMENDATION



NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
 B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE. D. DIMENSION AND TOLERANCE AS PER ASME
 - Y14.5-1994. E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
 - F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.
 - G. DRAWING FILE NAME: TO263A07REV5.



* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT <u>HTTP://WWW.FAIRCHILDSEMI.COM</u>, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

AUTHORIZED USE

Unless otherwise specified in this data sheet, this product is a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability. This product may not be used in the following applications, unless specifically approved in writing by a Fairchild officer: (1) automotive or other transportation, (2) military/aerospace, (3) any safety critical application – including life critical medical equipment – where the failure of the Fairchild product reasonably would be expected to result in personal injury, death or property damage. Customer's use of this product is subject to agreement of this Authorized Use policy. In the event of an unauthorized use of Fairchild's product, Fairchild accepts no liability in the event of product failure. In other respects, this product shall be subject to Fairchild's Worldwide Terms and Conditions of Sale, unless a separate agreement has been signed by both Parties.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Terms of Use

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 177

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: FDB0630N1507L